Ratings And Characteristic Curves

Fig.3 Typical Forward Characteristic

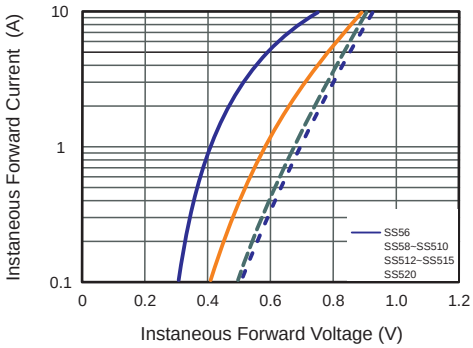
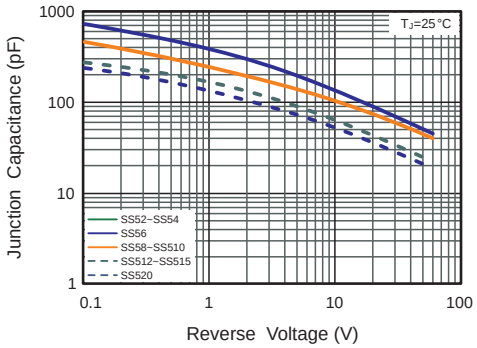


Fig.4 Typical Junction Capacitance



Marking Diagram

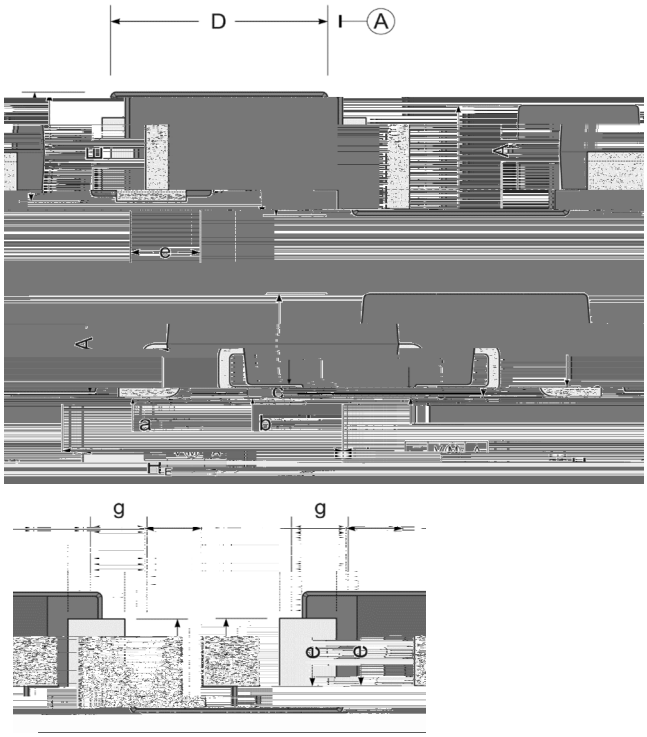


Ordering information

Package	Packing Description	Packing Quantity
DO-214AC SMA		

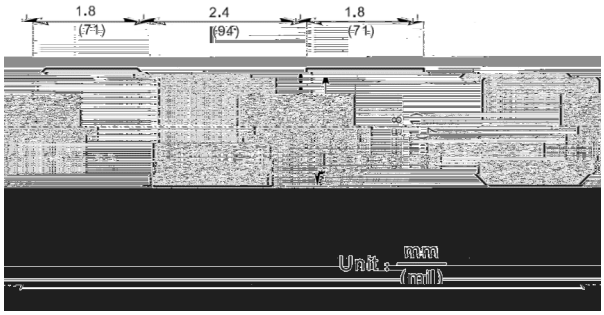
Package Dimensions

DO-214AC SMA



Dim.	Millimeter(mm)		mil	
	Min.	Max.	Min.	Max.

The recommended mounting pad size



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